

SML75HB06

Attributes:

- -aerospace build standard
- -high reliability
- -lightweight
- -metal matrix base plate
- -AIN isolation



Maximum rated values/ Electrical Properties

Collector-emitter Voltage		ces	600	V
DC Collector Current	Tc=75C Tc=25C	, nom Ic	75 100	A
Repetitive peak Collector Current	tp=1msec,Tc=75C	I_{crm}	150	A
Total PowerDissipation	Tc=25C	P _{tot}	260	W
Gate-emitter peak voltage		$V_{\rm ges}$	+/-20	V
DC Forward Diode Current		$ m I_f$	75	A
Repetitive Peak Forward Current	tp=1msec	$ m I_{frm}$	150	A
I ² t value per diode	Vr=0V, tp=10msec, Tvj=125C	I ² _t	500	A ² sec
Isolation test voltage	RMS, 50Hz, t=1min	V _{isol}	2500	V

Collector-emitter saturation voltage	Ic=75A,Vge=15V, Tc=25C Ic=75A,Vge=15V,Tc=125C	$V_{\text{ce(sat)}}$		1.95 2.2	2.45	V
Gate Threshold voltage	Vce=Vge, Tvj=25C	Vge _(th)	4.5	5.5	6.5	V
Input capacitance	f=1MHz,Tvj=25C,Vce=25V, Vge=0V	Cies		3.2		nF
Reverse transfer Capacitance	f=1MHz,Tvj=25C,Vce=25V, Vge=0V	C_{res}		0.3		nF
Collector emitter cut off current	Vce=600V,Vge=0V,Tvj=25C Vce=600V,Vge=0V,Tvj=125C	I_{ces}		1 1	500	μА
Gate emitter cut off current	Vce=0V,Vge=20V,Tvj=25C	I_{ges}			400	μА

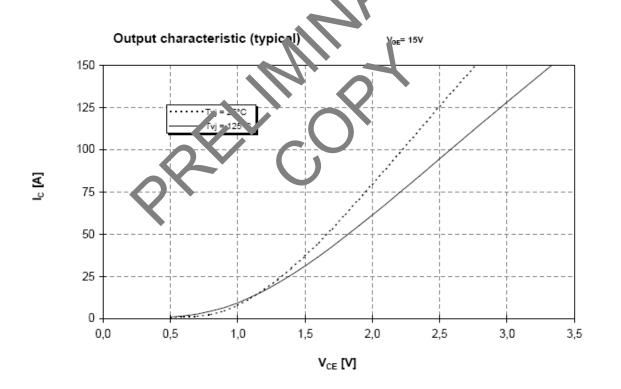
		T		1
Turn on delay time	Ic=75A, Vcc=300V Vge=+/15V,Rg=3Ω,Tvj=25C Vge=+/-15V,Rg=3Ω,Tvj=125C	$t_{ m d,on}$	63 65	nsec nsec
Rise time	Ic=75A, Vcc=300V Vge=+/-15V,Rg=3Ω,Tvj=25C Vge=+/-15V,Rg=3Ω,Tvj=125C	tr	22 1025	nsec nsec
Turn off delay time	Ic=75A, Vcc=300V Vge=+/-15V,Rg=3Ω,Tvj=25C Vge=+/-15V,Rg=3Ω,Tvj=125C	$t_{d, off}$	155 170	nsec nsec
Fall time	Ic=75A, Vcc=300V Vge=+/-15V,Rg=3Ω,Tvj=25C Vge=+/-15V,Rg=3Ω,Tvj=125C	$t_{ m f}$	20 35	nsec nsec
Turn energy loss per pulse	Ic=75A,Vce=300V,Vge=15 V Rge=2.7Ω,Tvj=125C,L=35m	E _{on}	0.7	mJ
Turn off energy loss per pulse	Ic=75A,Vce=300V, Vgc=75V Rge=Ω,Tvj=125C,L=30n H	E _{off}	2.4	mJ
SC Data	tp≤10µsec Vg ≤1.V Tvj≤125C, ⟨ =5 (0V,Vce(ma ⟨)- Vces-1 , di/d Γ	I_{sc}	340	A
Stray Module inductance		$L_{\sigma ce}$	40	nН
Terminal-chip resistance	· ~ O ·	R_c	1.2	mΩ

Diode characteristics

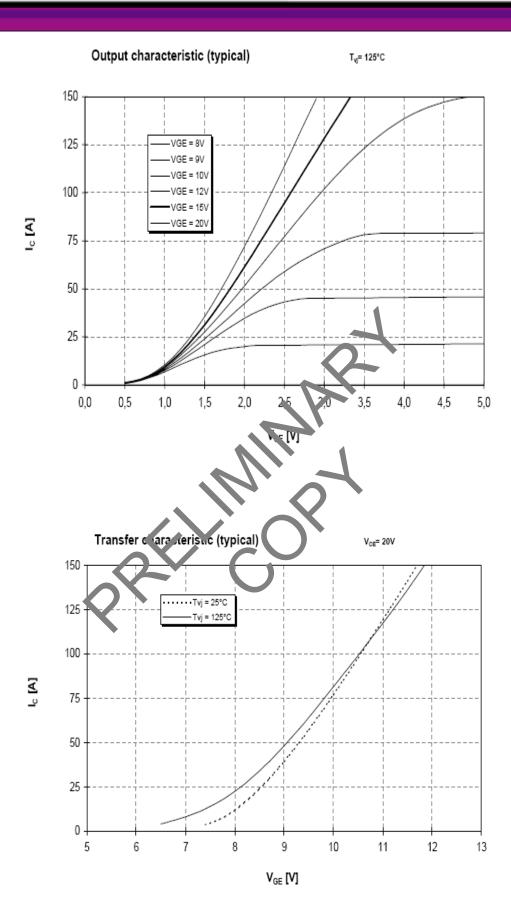
Forward voltage	Ic=75A,Vge=0V, Tc=25C Ic=75A,Vge=0V, Tc=125C	$V_{\rm f}$	1.25 1.2	1.6	V
Peak reverse recovery current	If=75A, -di/dt=3000A/μsec Vce=300V,Vge=-10V,Tvj=25C Vce=300V,Vge=-10V,Tvj=125C	I_{rm}	95 115		A
Recovered charge	If=75A, -di/dt=3000A/μsec Vce=600V,Vge=-10V,Tvj=25C Vce=600V,Vge=-10V,Tvj=125C	$Q_{\rm r}$	5.1 7.9		μC
Reverse recovery energy	If=75A, -di/dt=3000A/μsec Vce=600V,Vge=-10V,Tvj=25C Vce=600V,Vge=-10V,Tvj=125C	E _{rec}	2.3		mJ mJ



Thermal Properties			Min	Тур	Max	
Thermal resistance junction to case	Igbt Diode	$R_{\theta J\text{-}C}$			0.48 0.89	K/W
Thermal resistance case to heatsink		R _{0C-hs}		0.03		K/W
Maximum junction temperature		$T_{\rm vj}$			150	С
Maximum operating temperature		Тор	-55		125	С
Storage Temperature		T_{stg}	-55	1	125	С

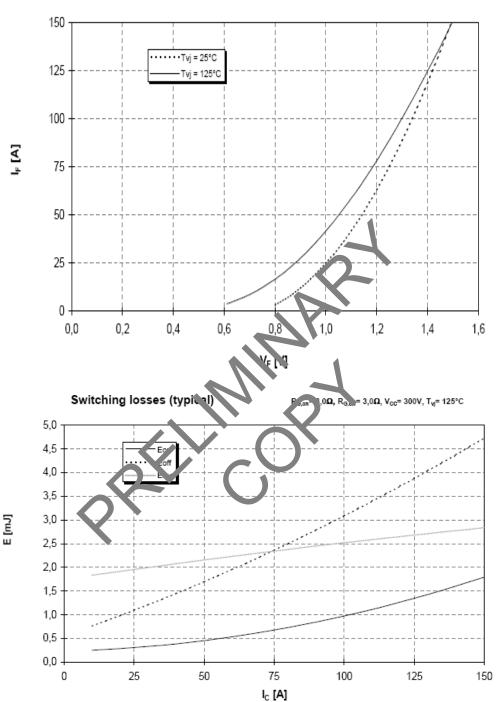


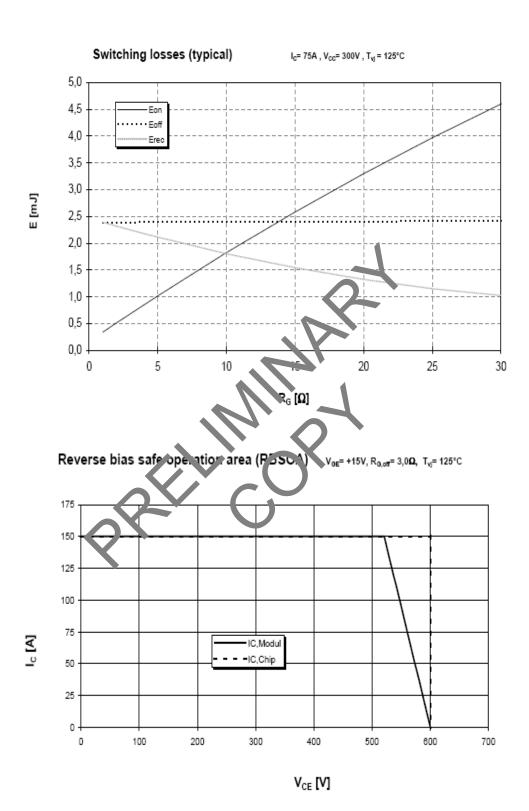






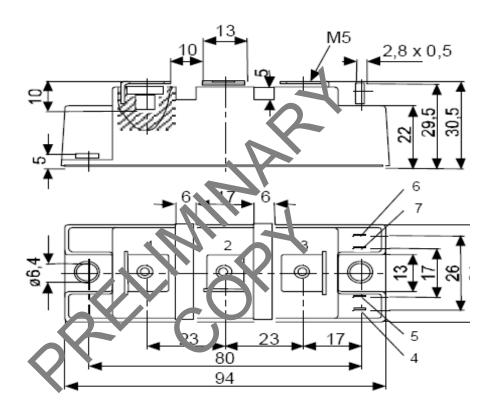
Forward characteristic of inverse diode (typical)

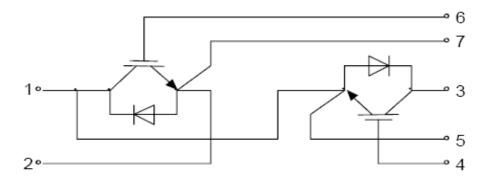






Package outline / Circuit diagram





CIRCUIT DIAGRAM